

## ZXCT1022 Low offset high-side current monitor

### Description

The ZXCT1022 is a precision high-side current sense monitor. Using this type of device eliminates the need to disrupt the ground plane when sensing a load current.

The ZXCT1022 provides a fixed gain of 100 for applications where minimal sense voltage is required.

The very low offset voltage enables a typical accuracy of 3% for sense voltages of only 10mV,

#### Features

- Accurate high-side current sensing
- Output voltage scaling
- 2.5V 20V supply range
- 25mA quiescent current
- 1% typical accuracy
- SOT23-5 package

**Pinout information** 

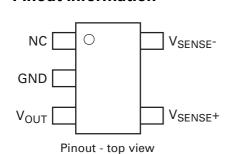
giving better tolerances for small sense resistors necessary at higher currents.

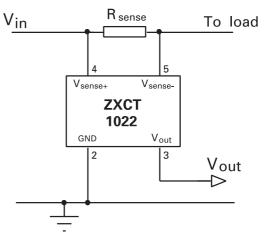
The wide input voltage range of 20V down to as low as 2.5V make it suitable for a range of applications. With a minimum operating current of just  $25\mu$ A, combined with its SOT23-5 package make it suitable for portable battery equipment too.

### Applications

- · Battery chargers
- Smart battery packs
- DC motor control
- Over current monitor
- Power management
- Level translating
- Programmable current source

### Typical application circuit





### **Ordering information**

Order reference	Package	Device marking	Status	Reel size (inches)	Quantity per reel	Tape width (mm)
ZXCT1022E5TA	SOT23-5	1022	Released	7	3000	8

## Absolute maximum ratings

Voltage on any pin with respect to END pin	-0.6V to 20V
V <sub>SENSE</sub>	-0.6V to $V_{IN}$ + 0.5V
Operating temperature	-40 to 85°C
Storage temperature	-55 to 150°C
Package power dissipation	$(T_{amb} = 25^{\circ}C)$
SOT23-5	450m $\Omega$

## **Pinout information**

Pin name	Pin function		
N/C	Not internally connected		
GND	Ground		
V <sub>OUT</sub>	Voltage output referenced to GND. Intended to drive high impedance loads		
V <sub>SENSE</sub> -	High impedance negative sense voltage input		
V <sub>SENSE</sub> +	Supply and positive sense voltage input		

Symbol	Parameter	Conditions	Limits			Unit
			Min.	Тур.	Max.	
V <sub>IN</sub>	V <sub>CC</sub> range		2.5		20	V
V <sub>OUT</sub>	Output voltage	V <sub>SENSE</sub> = 0V	0	30	100	mV
		V <sub>SENSE</sub> = 10mV	0.97	1.0	1.03	V
		V <sub>SENSE</sub> = 30mV	2.91	3.0	3.09	V
		V <sub>SENSE</sub> = 100mV	9.7	10.0	10.3	V
R <sub>OUT</sub>	Output resistance		10	15	20	kΩ
T <sub>C</sub> <sup>(*)</sup>	Output temperature coefficient			50	300	ppm
۱ <sub>0</sub>	Ground pin current	V <sub>SENSE</sub> = 0V		25	35	μA
V <sub>SENSE</sub> (†)	Sense voltage	V <sub>IN</sub> = 20V	0		180 <sup>(‡)</sup>	mV
I <sub>SENSE</sub>	Load pin current	V <sub>SENSE</sub> = 0V			100	nA
Acc	Accuracy	V <sub>SENSE</sub> = 10mV	-3		3	%
Gain	V <sub>OUT</sub> / V <sub>SENSE</sub>	V <sub>SENSE</sub> = 10mV	97	100	103	V/V
BW	Bandwidth	V <sub>SENSE</sub> = 10mV		300		kHz
		V <sub>SENSE</sub> = 100mV		2		MHz

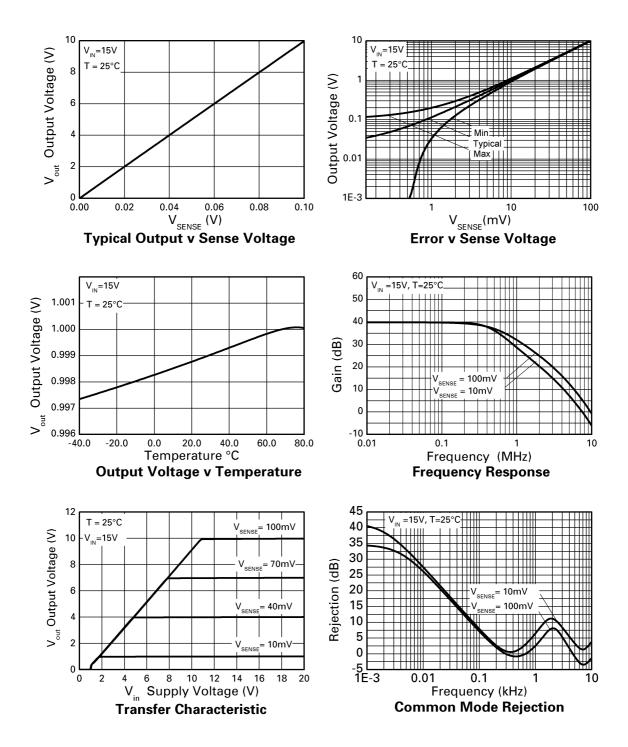
## Electrical characteristics test conditions $T_{amb} = 25^{\circ}C$ , $V_{IN} = 15V$

#### NOTES:

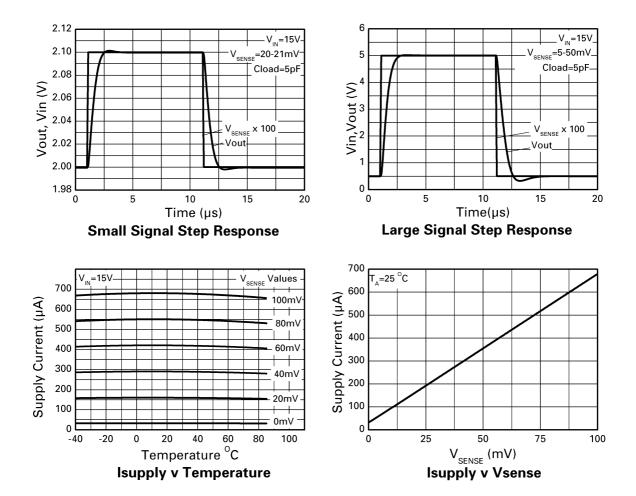
(\*)  $T_{C}$  limits are determined by characterization (†)  $V_{SENSE} = V_{IN} - V_{LOAD}$ (‡) For linear operation maximum  $V_{SENSE}$  is limited by operating voltage and is approximately:

$$V_{\text{SENSE}} = \frac{(V_{\text{IN}} - 2)}{100}$$

### **Typical characteristics**



## **Typical characteristics**



### **Application information**

The ZXCT1022 has a fixed dc voltage gain of 100. No external scaling resistors are required for the output. Output voltage is simply defined as:

### $V_{OUT} = 100 \times V_{SENSE} (V)$

Where  $V_{SENSE} = V_{IN} - V_{LOAD}$ 

### PCB trace shunt resistor for low cost solution

Figure 1 shows a PCB layout suggestion for a low cost solution where a PCB resistive trace in replacement for a conventional shunt resistor, can be used. The resistor section is 25mm x 0.25mm giving approximately 150m $\Omega$  using 1 oz copper. Smaller resistances can be used if required.

Total circuit solution: 1 component. Shows area of  $150m\Omega$  sense resistor compared to SOT23 package.

Practical tolerance of the PCB resistor will be around 5% depending on manufacturing methods.

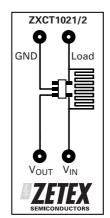
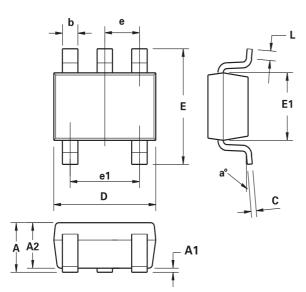


Figure 1 PCB layout suggestion

## Package outline - SOT23-5



DIM	Millimeters		Inc	hes
	Min.	Max.	Min.	Max.
A	0.90	1.45	0.0354	0.0570
A1	0.00	0.15	0.00	0.0059
A2	0.90	1.30	0.0354	0.0511
b	0.20	0.50	0.0078	0.0196
С	0.09	0.26	0.0035	0.0102
D	2.70	3.10	0.1062	0.1220
E	2.20	3.20	0.0866	0.1181
E1	1.30	1.80	0.0511	0.0708
е	0.95	REF	0.037	4 REF
e1	1.90 REF		0.0748 REF	
L	0.10	0.60	0.0039	0.0236
a°	0°	30°	0°	30°

Note: Controlling dimensions are in millimeters. Approximate dimensions are provided in inches

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